

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE15P25JK uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

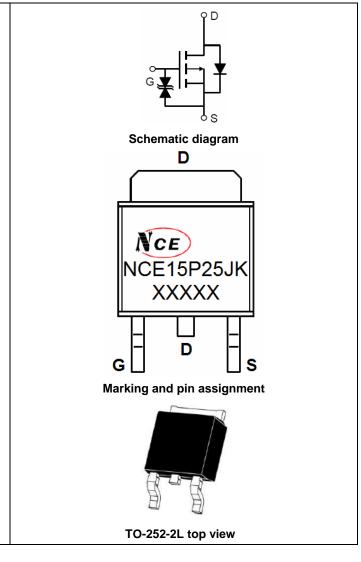
- V_{DS} =-150V, I_D =-25A $R_{DS(ON)}$ <150m Ω @ V_{GS} =-10V (Typ.=120mR) $R_{DS(ON)}$ <160m Ω @ V_{GS} =-4.5V (Typ.=131mR)
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

Application

• Portable equipment and battery powered systems

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE15P25JK	NCE15P25JK	TO-252-2L	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	-145	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	Ι _D	-25	А
Drain Current-Continuous(T _C =100℃)	l _D (100℃)	-17	A
Pulsed Drain Current	I _{DM}	-140	A
Maximum Power Dissipation	PD	160	W
Derating factor		1.3	W/℃
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	°C



Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	0.8	°C /W
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	40	°C/W

Electrical Characteristics (T_c=25[°]Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-145	-155	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-145V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±10	μA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.5	-1.9	-3	V	
Desire Oscillator Oscillator Desistantes		V _{GS} =-10V, I _D =-20A	-	120	150	mΩ	
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =-4.5V, I _D =-20A	-	131	160		
Forward Transconductance	g fs	V _{DS} =-5V,I _D =-20A	5	-	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C _{lss}		-	7650	-	PF	
Output Capacitance	C _{oss}	V_{DS} =-75V, V_{GS} =0V,	-	148	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	131	-	PF	
Switching Characteristics (Note 4)			ł			•	
Turn-on Delay Time	t _{d(on)}		-	17	-	nS	
Turn-on Rise Time	tr	V _{DD} =-75V,I _D =-20A	-	80	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =9.1 Ω	-	45	-	nS	
Turn-Off Fall Time	t _f		-	65	-	nS	
Total Gate Charge	Qg	\/	-	137	-	nC	
Gate-Source Charge	Q _{gs}	V_{DS} =-75V,I _D =-20A,	-	25	-	nC	
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	28	-	nC	
Drain-Source Diode Characteristics			I			1	
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-25A	-	-	-1.2	V	
Diode Forward Current (Note 2)	Is	-	-	-	-25	Α	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =-25A	-	90	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	105	-	nC	
						I	

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^{\circ}$ C. The the maximum allowed junction temperature of 150° C

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

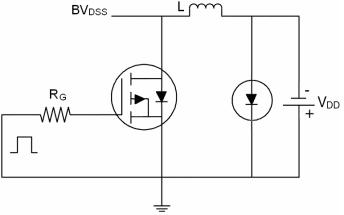
4. Guaranteed by design, not subject to production

5. EAS condition: Tj=25 $^{\circ}C$,V_{DD}=-75V,V_G=-10V,L=0.5mH,Rg=25\Omega

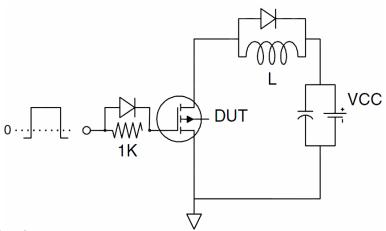


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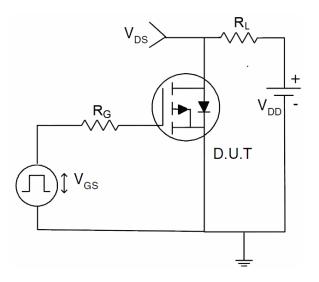
Test Circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit

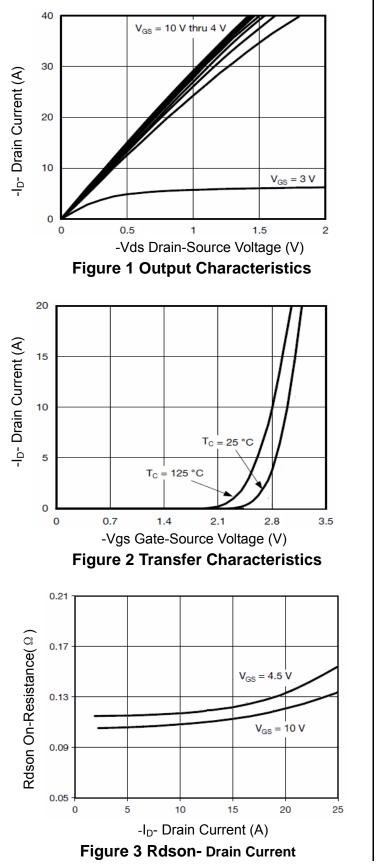


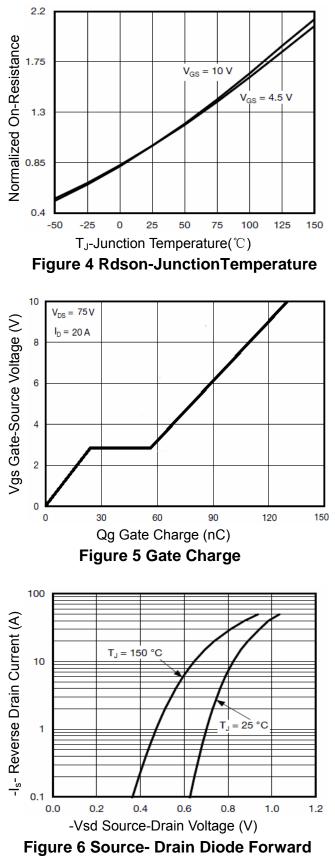
3) Switch Time Test Circuit





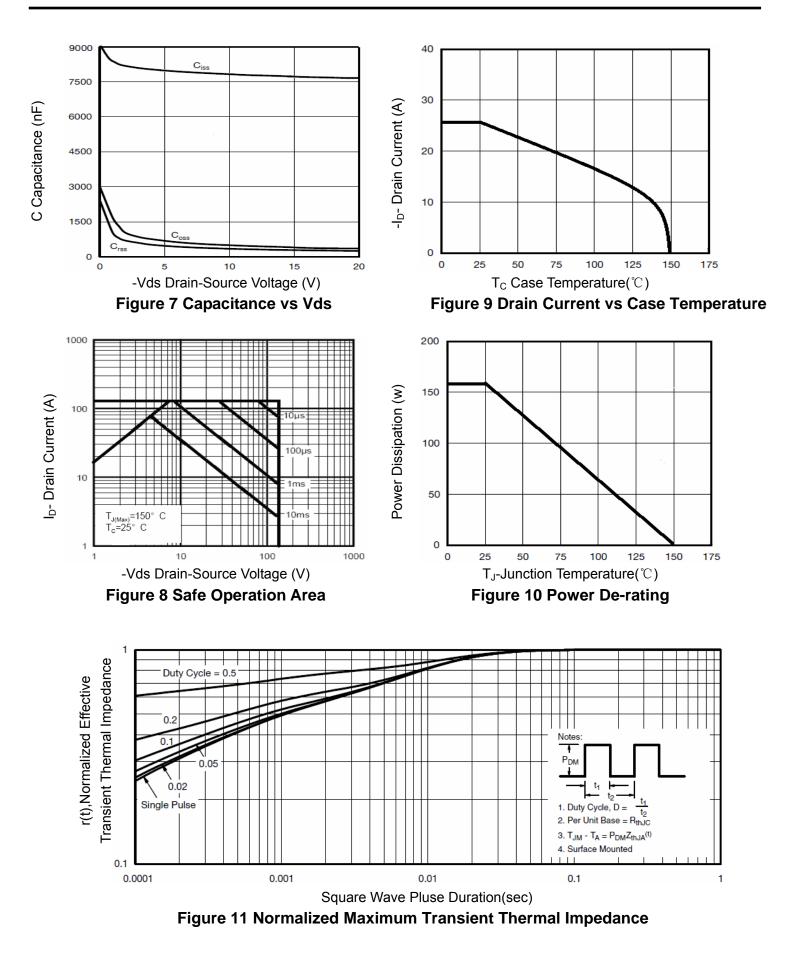
Typical Electrical and Thermal Characteristics (Curves)







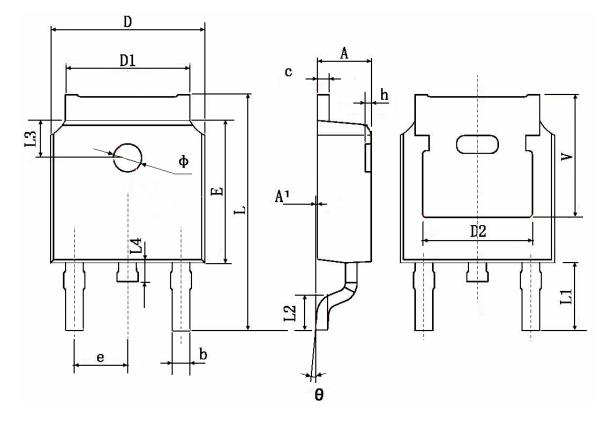
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TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.83	TYP.	0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350) TYP.	0.211 TYP.		



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